

## Features

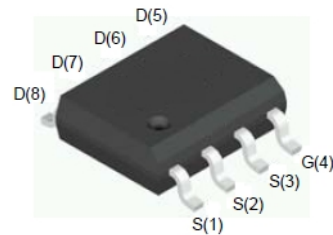
- 60V/5A,  
 $R_{DS(ON)} = 60m\Omega$  (Typ.) @  $V_{GS}=10V$   
 $R_{DS(ON)} = 70m\Omega$  (Typ.) @  $V_{GS}=4.5V$
- Super High Dense Cell Design
- Reliable and Rugged
- ESD Protected
- Lead Free and Green Available

## Applications

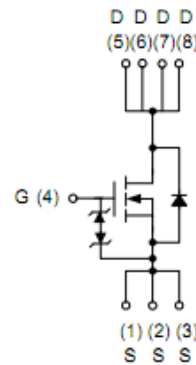
- Power Management
- Switch Applications

## Absolute Maximum Ratings

## Pin Description



SOP-8



N-Channel MOSFET

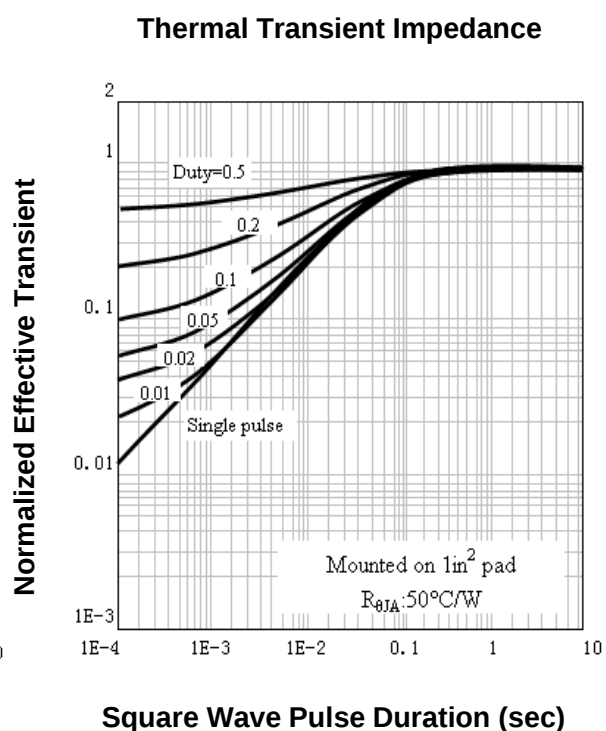
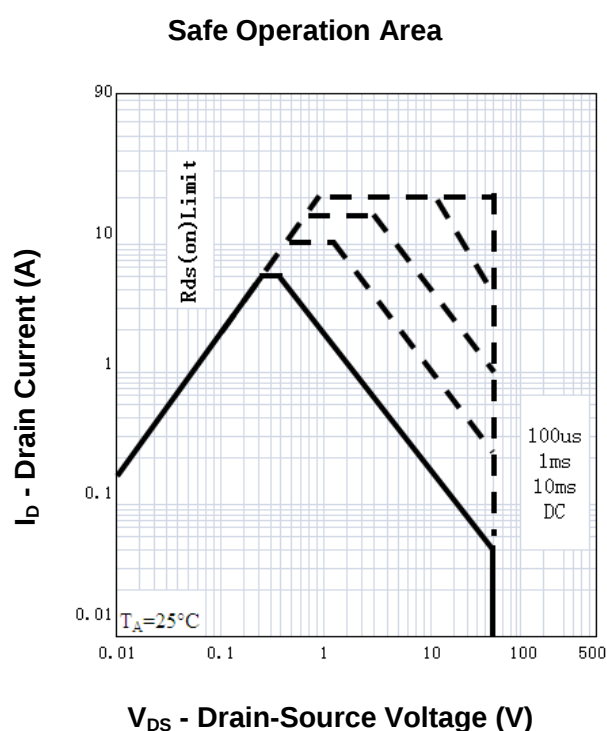
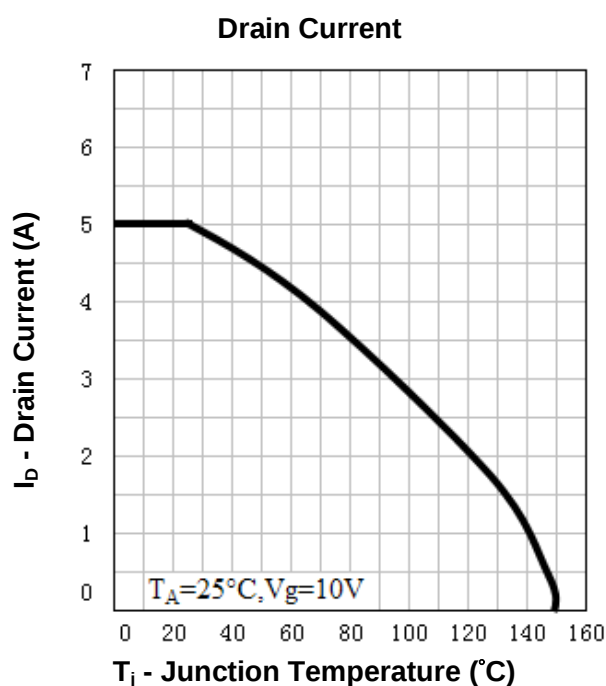
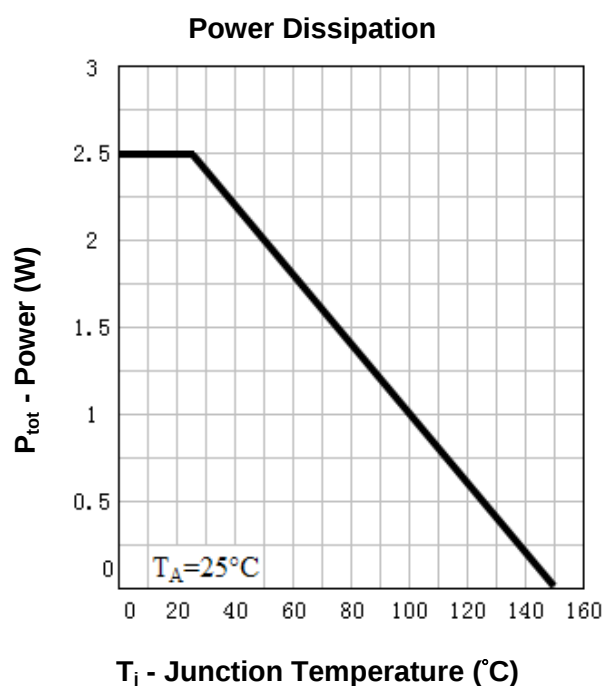
| Symbol                                                       | Parameter                                      |                      | Rating          | Unit |
|--------------------------------------------------------------|------------------------------------------------|----------------------|-----------------|------|
| Common Ratings (T <sub>A</sub> =25°C Unless Otherwise Noted) |                                                |                      |                 |      |
| V <sub>DSS</sub>                                             | Drain-Source Voltage                           |                      | 60              | V    |
| V <sub>GSS</sub>                                             | Gate-Source Voltage                            |                      | ±20             |      |
| T <sub>J</sub>                                               | Maximum Junction Temperature                   |                      | 150             | °C   |
| T <sub>STG</sub>                                             | Storage Temperature Range                      |                      | -55 to 150      | °C   |
| I <sub>S</sub>                                               | Diode Continuous Forward Current               | T <sub>A</sub> =25°C | 3               | A    |
| Mounted on Large Heat Sink                                   |                                                |                      |                 |      |
| I <sub>DP</sub>                                              | 300μs Pulse Drain Current Tested               | T <sub>A</sub> =25°C | 20 <sup>①</sup> | A    |
| I <sub>D</sub>                                               | Continuous Drain Current(V <sub>GS</sub> =10V) | T <sub>A</sub> =25°C | 5               | A    |
|                                                              |                                                | T <sub>A</sub> =70°C | 3.7             |      |
| P <sub>D</sub>                                               | Maximum Power Dissipation                      | T <sub>A</sub> =25°C | 2.5             | W    |
|                                                              |                                                | T <sub>A</sub> =70°C | 1.6             |      |
| R <sub>θJA</sub> <sup>②</sup>                                | Thermal Resistance-Junction to Ambient         |                      | 50              | °C/W |

**Electrical Characteristics** ( $T_A=25^{\circ}\text{C}$  Unless Otherwise Noted)

| Symbol                        | Parameter                        | Test Condition                                                                                               | RU60E5H |      |      | Unit |
|-------------------------------|----------------------------------|--------------------------------------------------------------------------------------------------------------|---------|------|------|------|
|                               |                                  |                                                                                                              | Min.    | Typ. | Max. |      |
| Static Characteristics        |                                  |                                                                                                              |         |      |      |      |
| BV <sub>DSS</sub>             | Drain-Source Breakdown Voltage   | V <sub>GS</sub> =0V, I <sub>DS</sub> =250μA                                                                  | 60      |      |      | V    |
| I <sub>DSS</sub>              | Zero Gate Voltage Drain Current  | V <sub>DS</sub> = 60V, V <sub>GS</sub> =0V                                                                   |         |      | 1    | μA   |
|                               |                                  | T <sub>J</sub> =85°C                                                                                         |         |      | 30   |      |
| V <sub>GS(th)</sub>           | Gate Threshold Voltage           | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250μA                                                    | 1.5     | 2    | 2.7  | V    |
| I <sub>GSS</sub>              | Gate Leakage Current             | V <sub>GS</sub> =±16V, V <sub>DS</sub> =0V                                                                   |         |      | ±10  | μA   |
| R <sub>DS(ON)</sub> ③         | Drain-Source On-state Resistance | V <sub>GS</sub> = 10V, I <sub>DS</sub> =5A                                                                   |         | 60   | 70   | mΩ   |
|                               |                                  | V <sub>GS</sub> = 4.5V, I <sub>DS</sub> =3.5A                                                                |         | 70   | 80   | mΩ   |
| Diode Characteristics         |                                  |                                                                                                              |         |      |      |      |
| V <sub>SD</sub> ③             | Diode Forward Voltage            | I <sub>SD</sub> =2.5A, V <sub>GS</sub> =0V                                                                   |         |      | 1.2  | V    |
| t <sub>rr</sub>               | Reverse Recovery Time            | I <sub>SD</sub> =2.5A, dI <sub>SD</sub> /dt=100A/μs                                                          |         | 41   |      | ns   |
| Q <sub>rr</sub>               | Reverse Recovery Charge          |                                                                                                              |         | 71   |      | nC   |
| Dynamic Characteristics ④     |                                  |                                                                                                              |         |      |      |      |
| R <sub>G</sub>                | Gate Resistance                  | V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, F=1MHz                                                             |         | 0.7  |      | Ω    |
| C <sub>iss</sub>              | Input Capacitance                | V <sub>GS</sub> =0V, V <sub>DS</sub> = 30V, Frequency=1.0MHz                                                 |         | 460  |      | pF   |
| C <sub>oss</sub>              | Output Capacitance               |                                                                                                              |         | 44   |      |      |
| C <sub>rss</sub>              | Reverse Transfer Capacitance     |                                                                                                              |         | 24   |      |      |
| t <sub>d(ON)</sub>            | Turn-on Delay Time               | V <sub>DD</sub> =30V, R <sub>L</sub> =12Ω, I <sub>DS</sub> =2.5A, V <sub>GEN</sub> = 10V, R <sub>G</sub> =6Ω |         | 3    |      | ns   |
| t <sub>r</sub>                | Turn-on Rise Time                |                                                                                                              |         | 4    |      |      |
| t <sub>d(OFF)</sub>           | Turn-off Delay Time              |                                                                                                              |         | 12   |      |      |
| t <sub>f</sub>                | Turn-off Fall Time               |                                                                                                              |         | 5    |      |      |
| Gate Charge Characteristics ④ |                                  |                                                                                                              |         |      |      |      |
| Q <sub>g</sub>                | Total Gate Charge                | V <sub>DS</sub> =48V, V <sub>GS</sub> = 10V, I <sub>DS</sub> =2.5A                                           |         | 16   | 21   | nC   |
| Q <sub>gs</sub>               | Gate-Source Charge               |                                                                                                              |         | 3    |      |      |
| Q <sub>gd</sub>               | Gate-Drain Charge                |                                                                                                              |         | 5    |      |      |

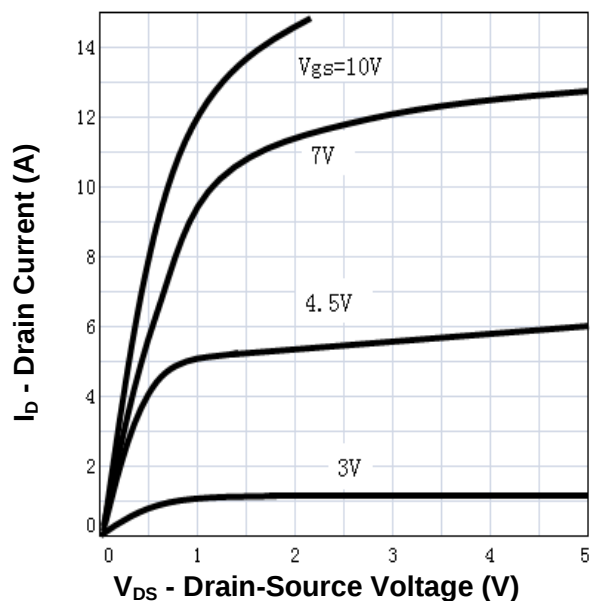
- Notes: ① Pulse width limited by safe operating area.  
 ② When mounted on 1 inch square copper board,  $t \leq 10\text{sec}$ .  
 ③ Pulse test ; Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .  
 ④ Guaranteed by design, not subject to production testing.

## Typical Characteristics

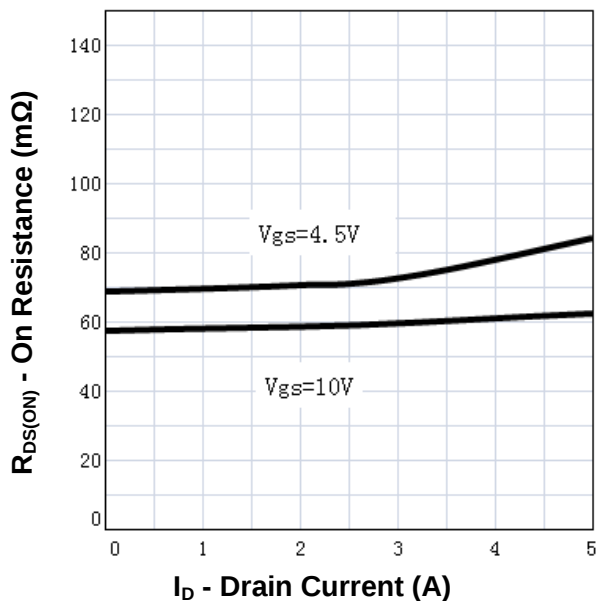


## Typical Characteristics

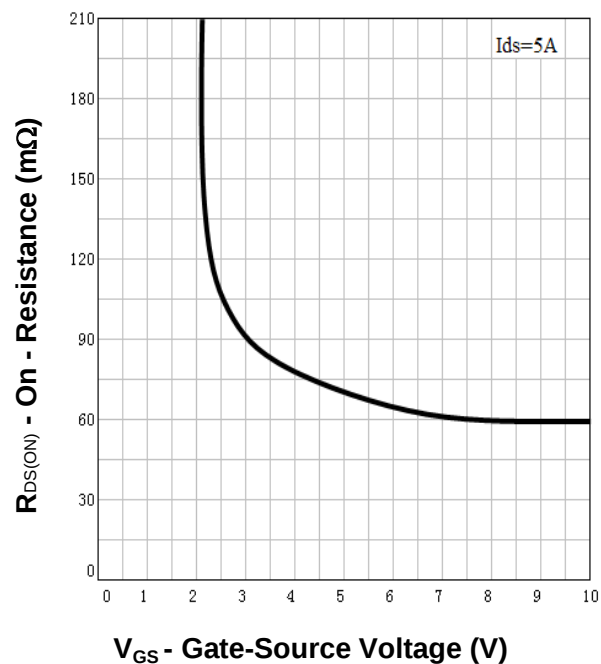
**Output Characteristics**



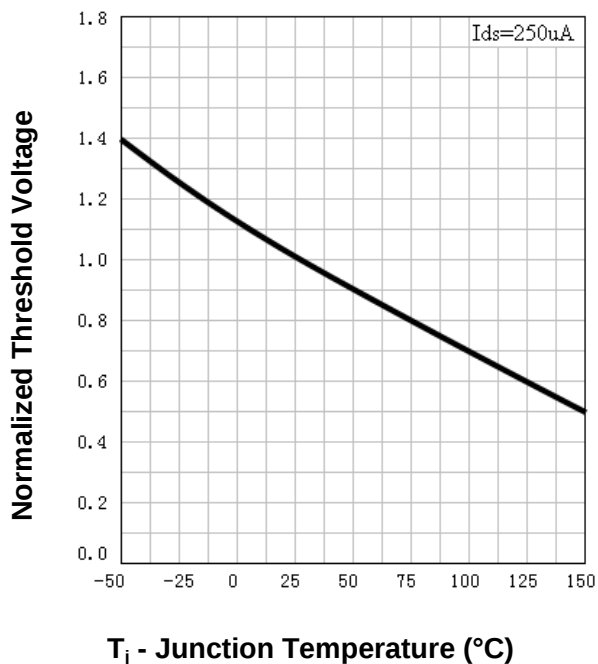
**Drain-Source On Resistance**



**Drain-Source On Resistance**

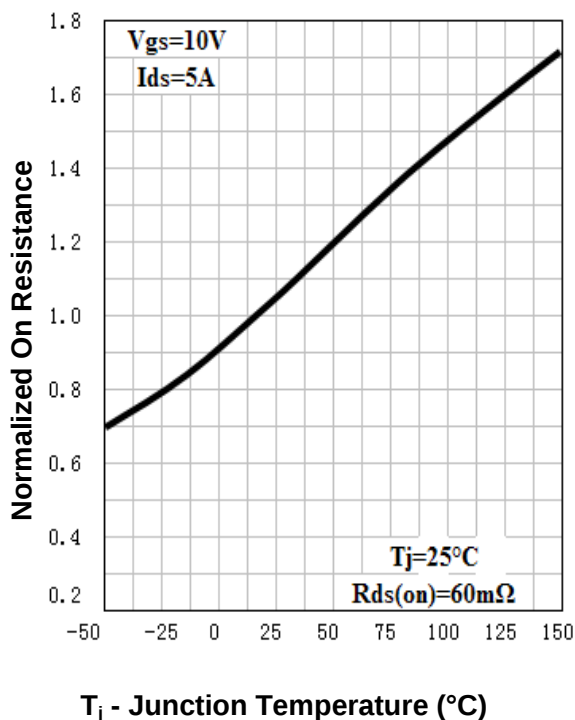


**Gate Threshold Voltage**

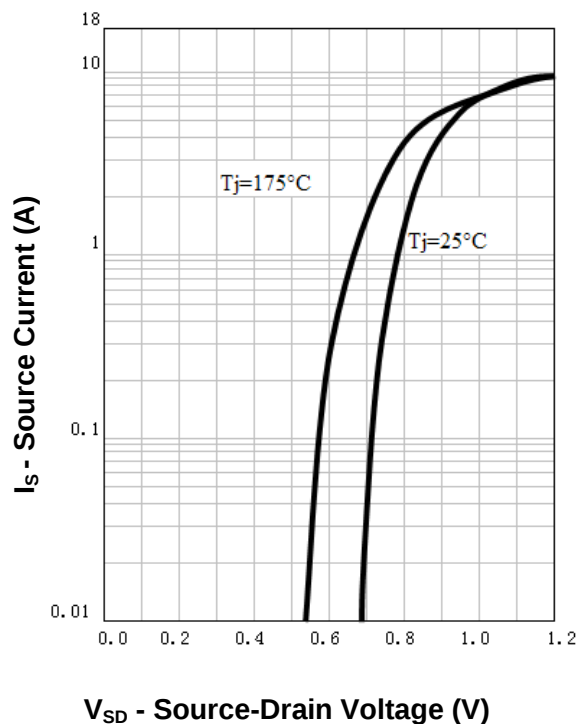


## Typical Characteristics

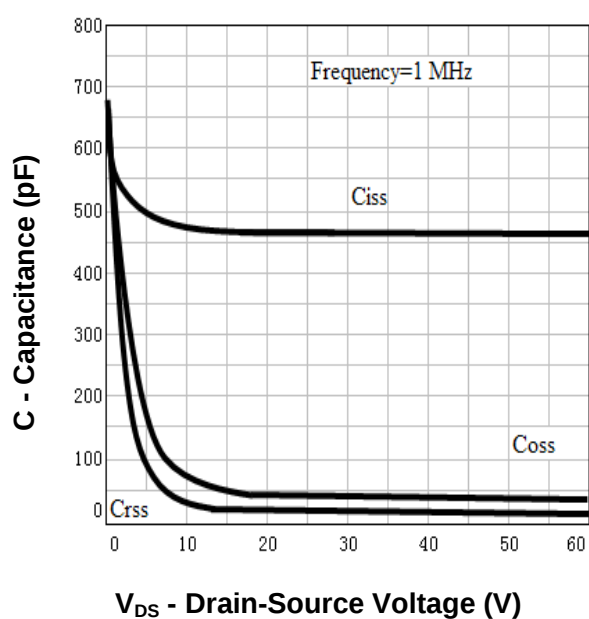
**Drain-Source On Resistance**



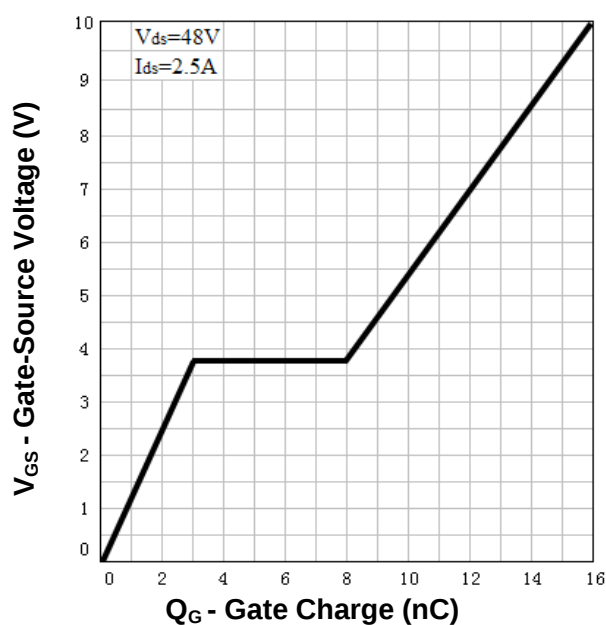
**Source-Drain Diode Forward**



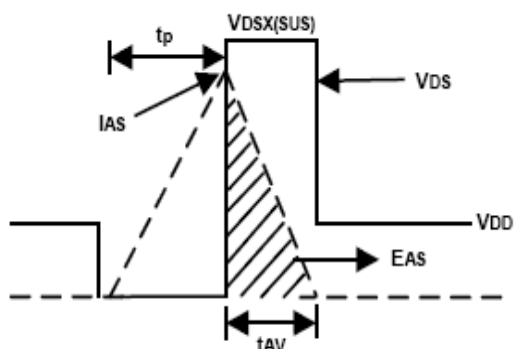
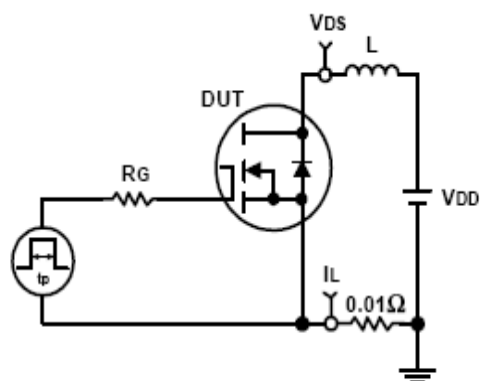
**Capacitance**



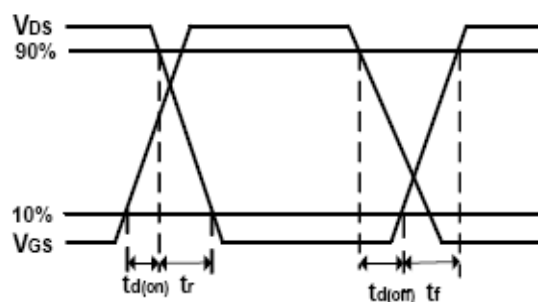
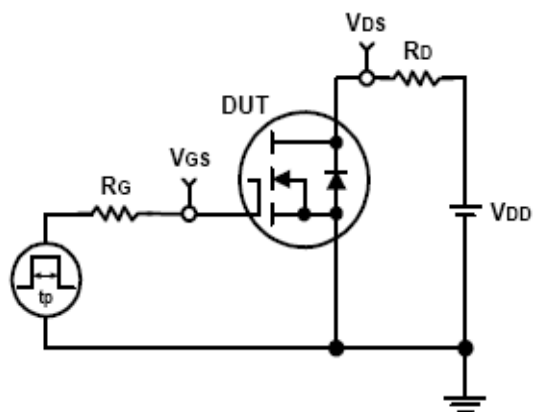
**Gate Charge**



## Avalanche Test Circuit and Waveforms



## Switching Time Test Circuit and Waveforms

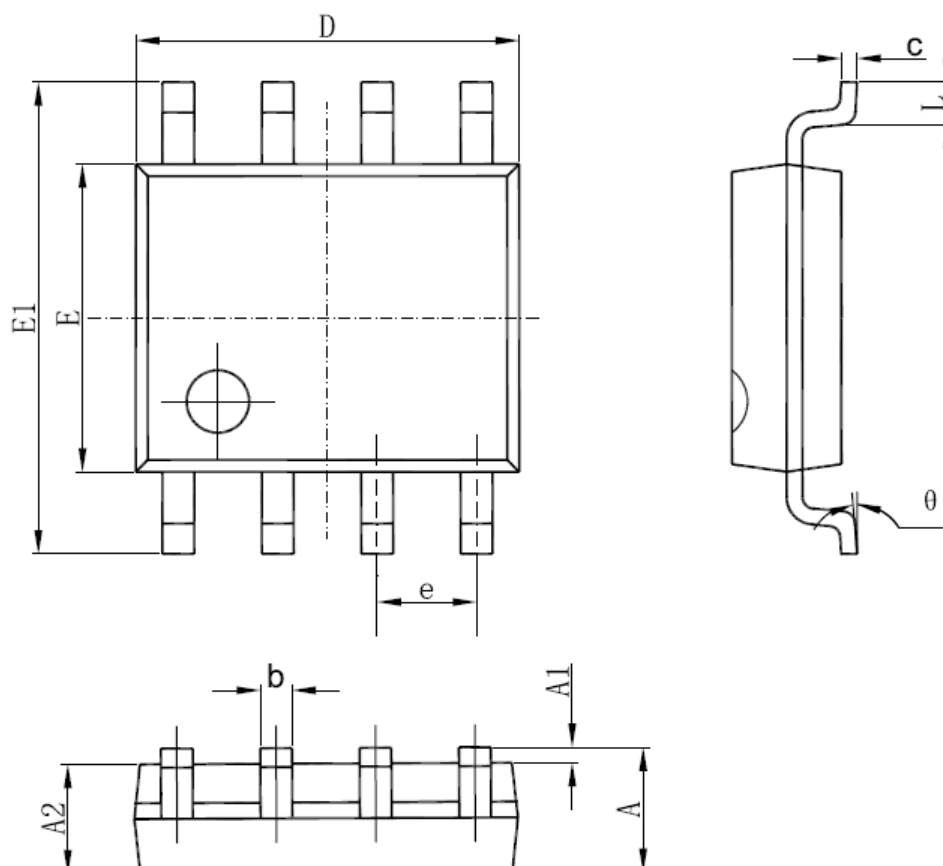


**Ordering and Marking Information**

| Device  | Marking | Package | Packaging | Quantity | Reel Size | Tape width |
|---------|---------|---------|-----------|----------|-----------|------------|
| RU60E5H | RU60E5H | SOP-8   | Tape&Reel | 2500     | 13''      | 12mm       |

## Package Information

### SOP-8



| SYMBOL | MM    |       | INCH  |       | SYMBOL | MM          |       | INCH        |       |
|--------|-------|-------|-------|-------|--------|-------------|-------|-------------|-------|
|        | MIN   | MAX   | MIN   | MAX   |        | MIN         | MAX   | MIN         | MAX   |
| A      | 1.350 | 1.750 | 0.053 | 0.069 | E      | 3.800       | 4.000 | 0.150       | 0.157 |
| A1     | 0.100 | 0.250 | 0.004 | 0.010 | E1     | 5.800       | 6.200 | 0.228       | 0.244 |
| A2     | 1.350 | 1.550 | 0.053 | 0.061 | e      | 1.270 (BSC) |       | 0.050 (BSC) |       |
| b      | 0.330 | 0.510 | 0.013 | 0.020 | L      | 0.400       | 1.270 | 0.016       | 0.050 |
| c      | 0.170 | 0.250 | 0.006 | 0.010 | θ      | 0°          | 8°    | 0°          | 8°    |
| D      | 4.700 | 5.100 | 0.185 | 0.200 |        |             |       |             |       |

ALL DIMENSIONS REFER TO JEDEC STANDARD  
DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS

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